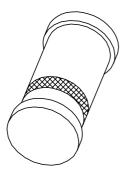
## DISCRETE SEMICONDUCTORS

# DATA SHEET



# BAV100 to BAV103 General purpose diodes

Product specification Supersedes data of April 1996 1996 Sep 17





## **General purpose diodes**

#### **BAV100 to BAV103**

#### **FEATURES**

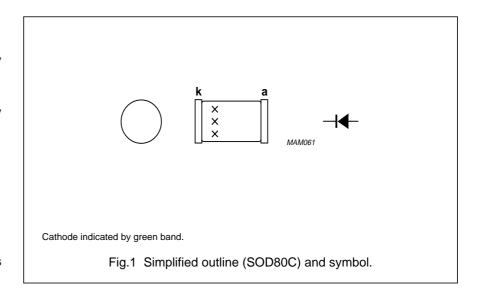
- Small hermetically sealed glass SMD package
- Switching speed: max. 50 ns
- · General application
- Continuous reverse voltage: max. 50 V, 100 V, 150 V and 200 V respectively
- Repetitive peak reverse voltage: max. 60 V, 120 V, 200 V and 250 V respectively
- Repetitive peak forward current: max. 625 mA.

#### **APPLICATIONS**

 Switching in industrial equipment e.g. oscilloscopes, digital voltmeters and video output stages in colour television.

#### **DESCRIPTION**

The BAV100 to BAV103 are switching diodes fabricated in planar technology, and encapsulated in small hermetically sealed glass SOD80C SMD packages.



# General purpose diodes

## **BAV100 to BAV103**

#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>RRM</sub>	repetitive peak reverse voltage				
	BAV100		_	60	V
	BAV101		_	120	V
	BAV102		_	200	V
	BAV103		_	250	V
$V_R$	continuous reverse voltage				
	BAV100		_	50	V
	BAV101		_	100	V
	BAV102		_	150	V
	BAV103		_	200	V
I <sub>F</sub>	continuous forward current	see Fig.2; note 1	_	250	mA
I <sub>FRM</sub>	repetitive peak forward current		_	625	mA
I <sub>FSM</sub>	non-repetitive peak forward current	square wave; T <sub>j</sub> = 25 °C prior to surge; see Fig.4			
		t = 1 μs	_	9	Α
		t = 100 μs	_	3	Α
		t = 1 s	_	1	Α
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C; note 1	_	400	mW
T <sub>stg</sub>	storage temperature		-65	+175	°C
Tj	junction temperature		_	175	°C

#### Note

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<sup>1.</sup> Device mounted on an FR4 printed-circuit board.

# General purpose diodes

## **BAV100 to BAV103**

#### **ELECTRICAL CHARACTERISTICS**

 $T_j$  = 25 °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>F</sub>	forward voltage	see Fig.3			
		I <sub>F</sub> = 100 mA	_	1.0	V
		I <sub>F</sub> = 200 mA	_	1.25	V
I <sub>R</sub>	reverse current	see Fig.5			
	BAV100	V <sub>R</sub> = 50 V	_	100	nA
		V <sub>R</sub> = 50 V; T <sub>j</sub> = 150 °C	_	100	μΑ
	BAV101	V <sub>R</sub> = 100 V	_	100	nA
		V <sub>R</sub> = 100 V; T <sub>j</sub> = 150 °C	_	100	μΑ
	BAV102	V <sub>R</sub> = 150 V	_	100	nA
		V <sub>R</sub> = 150 V; T <sub>j</sub> = 150 °C	_	100	μΑ
	BAV103	V <sub>R</sub> = 200 V	_	100	nA
		$V_R = 200 \text{ V}; T_j = 150 ^{\circ}\text{C}$	_	100	μΑ
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 0; see Fig.6	_	5	pF
t <sub>rr</sub>	reverse recovery time	when switched from $I_F$ = 30 mA to $I_R$ = 30 mA; $R_L$ = 100 $\Omega$ ; measured at $I_R$ = 3 mA; see Fig.8	_	50	ns

#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-tp</sub>	thermal resistance from junction to tie-point		300	K/W
R <sub>th j-a</sub>	thermal resistance from junction to ambient	note 1	375	K/W

#### Note

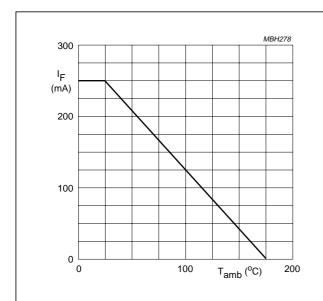
1. Device mounted on an FR4 printed-circuit board.

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## General purpose diodes

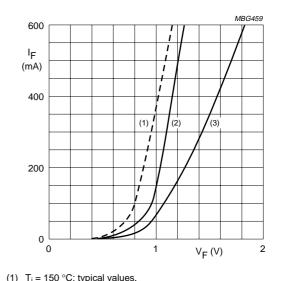
## **BAV100 to BAV103**

#### **GRAPHICAL DATA**



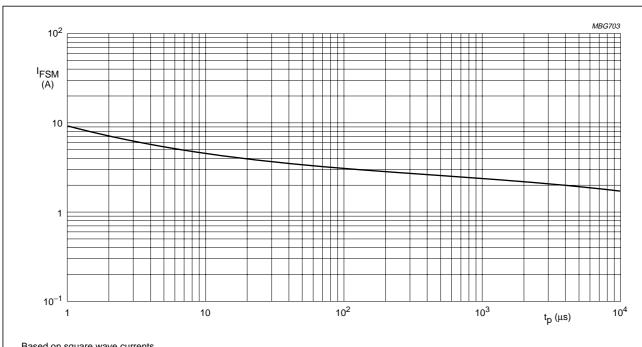
Device mounted on an FR4 printed-circuit board.

Fig.2 Maximum permissible continuous forward current as a function of ambient temperature.



- (1)  $T_i = 150$  °C; typical values.
- (2)  $T_i = 25 \,^{\circ}\text{C}$ ; typical values.
- (3)  $T_j = 25$  °C; maximum values.

Forward current as a function of forward voltage.



Based on square wave currents.

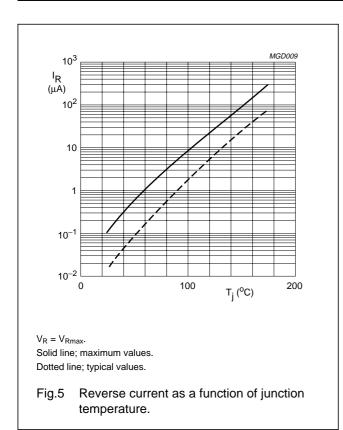
 $T_j = 25$  °C prior to surge.

Fig.4 Maximum permissible non-repetitive peak forward current as a function of pulse duration.

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# General purpose diodes

## **BAV100 to BAV103**



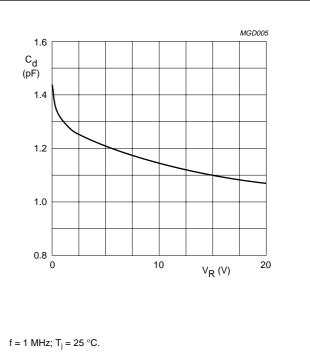
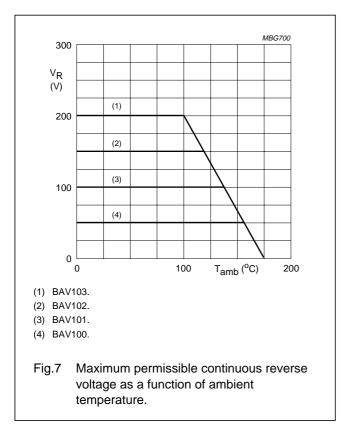
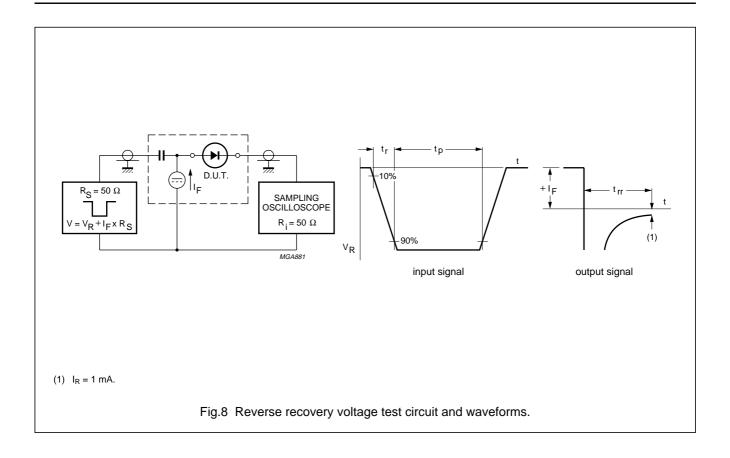


Fig.6 Diode capacitance as a function of reverse voltage; typical values.



# General purpose diodes

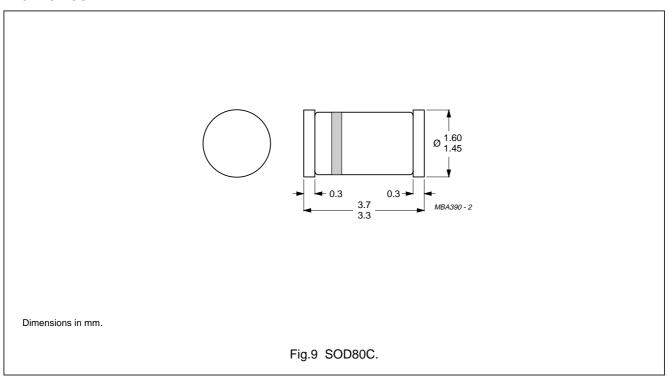
## **BAV100 to BAV103**



## General purpose diodes

#### **BAV100 to BAV103**

#### **PACKAGE OUTLINE**



#### **DEFINITIONS**

Data Sheet Status			
Objective specification	This data sheet contains target or goal specifications for product development.		
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.		
Product specification	This data sheet contains final product specifications.		
Limiting values			
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or			

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

#### **Application information**

Where application information is given, it is advisory and does not form part of the specification.

#### LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

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